## 12 TO 50 VOLT INPUT - 1.5 WATT

## **FEATURES**

- Small footprint, 0.79 in<sup>2</sup> (5.1 cm<sup>2</sup>) MCH
- · Surface mount package MGH
- Operating temperature -55°C to +125°C
- 12 to 50 volt input
- Transient protection 80 volts for up to 120 ms 70 volts for 15 volt single and dual models
- · Fully isolated, magnetic feedback
- · Fixed frequency switching
- · Inhibit function
- · Short circuit protection
- · Undervoltage lockout
- Up to 79% efficiency, typical
- Soft-start function limits inrush current during start-up





MODELS						
OUTPUT VOLTAGE (V)						
SINGLE DUAL						
5	±5					
12	±12					
15	±15					

## **DESCRIPTION**

The Interpoint® MCH Series™ and MGH Series™ of DC-DC converters offers up to 1.5 watts of power in a low profile package. The MCH/MGH converters are manufactured in our fully certified and qualified MIL-PRF-38534 Class H production facility and are packaged in hermetically sealed steel cases. They are ideal for use in programs requiring high reliability, small size, and high efficiency. The wide input voltage range of 12 to 50 volts accepts the varying voltages of military, aerospace, or space bus power and tightly regulates output voltages to protect downstream components. Transient protection of 80 volts for up to 120 milliseconds exceeds the requirements of MIL-STD-704A for the 5 and 12 volt single models and the 5 and 12 volt dual models. The 15 volt single and dual converters will withstand transients of up to 70 volts for up to 120 milliseconds.

The MCH and MGH converters are offered with standard screening, / ES, or /883 (MIL-PRF-38534 Class H). See Table 12 on page 14. Standard microcircuit drawings (SMD) are available. See Table 3 on page 4 and Table 8 on page 6.

#### CONVERTER DESIGN

MCH Series and MGH Series of DC-DC converters incorporate a continuous flyback topology with a constant switching frequency of approximately 370 kHz. Current-mode pulse width modulation (PWM) provides output voltage regulation. Output error voltage is magnetically fed back to the input side of the PWM to regulate output voltage. Regulation is also affected by the load; refer to Table 10 on page 8 and Table 11 on page 9.

Dual models regulate the negative output with magnetic coupling to the positive output. Up to 80% of the total load may be on one output providing that the other output carries a minimum of 20% of the total load. The dual models can be used at double the output voltage by connecting the load between positive and negative outputs, leaving the common unconnected.

(ex: MCH2805D can be used as a 10 volt output.)

## INHIBIT FUNCTION

MCH and MGH converters provide an inhibit terminal that can be used to disable internal switching, resulting in no output voltage and an input current as low as 2.3 mA. The converter is inhibited when the inhibit pin is pulled below 0.8 V and enabled when its inhibit pin is left floating. An external inhibit interface should be capable of pulling the converter's inhibit pin below 0.8 V while sinking the maximum inhibit current and also allowing the inhibit pin to float high to enable the converter. A voltage should not be applied to the inhibit pin. The open circuit voltage present on the inhibit pin is 7 to 12 volts.

#### **PROTECTION FEATURES**

Undervoltage lockout prevents the converters from operating below approximately 8 volts input voltage to keep system current levels smooth, especially during initialization or re-start operations. All models include a soft-start function to prevent large current draw and minimize overshoot. The converters also provide short circuit protection by restricting the current.



## **12 TO 50 VOLT INPUT - 1.5 WATT**

## MIL-STD-461

Use the Interpoint FMSA-461 (down-leaded) or FMGA-461 (surface mount, side-leaded) EMI filters to pass the CEO3 requirements of MIL-STD-461C.

## **PACKAGING**

MCH - Down-leaded package

The MCH Series converters are packaged in hermetically sealed, projection-welded steel cases which provide EMI/RFI shielding. See Figure 20 on page 12.

## MGH - Surface mount package

The surface mount MGH DC-DC converters can be mounted with pick-and-place equipment or manually. It is recommended that the case be attached with flexible epoxy adhesive or silicone which is thermally conductive (>1 watt/meter/°K).

Internal components are soldered with SN96 (melting temperature 221°C) to prevent damage during reflow. Maximum reflow temperature for surface mounting the MGH converter is 220°C for a maximum of 30 seconds. SN60, 62, or 63 are the recommended types of solder. Hand soldering should not exceed 300°C for 10 seconds per pin.

The hermetically sealed metal cases are available in two different lead configurations. See Figure 21 on page 13 and Figure 22 on page 13.

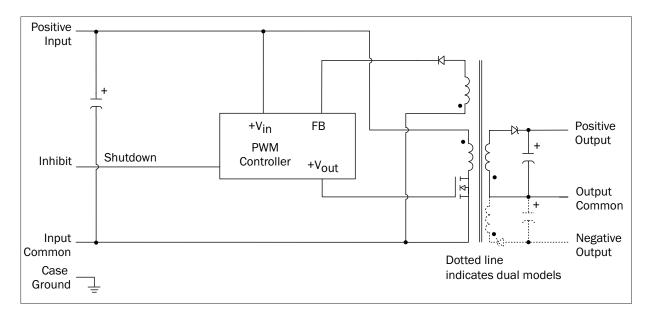


FIGURE 1: MCH/MGH BLOCK DIAGRAM

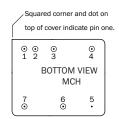
# **12 TO 50 VOLT INPUT - 1.5 WATT**

PIN OUT MCH MODELS								
Pin	Single Output	<b>Dual Output</b>						
1	Positive Input	Positive Input						
2	Input Common	Input Common						
3	Positive Output	Positive Output						
4	Output Common	Output Common						
5	Case Ground	Case Ground						
6	No Connection	Negative Output						
7	Inhibit	Inhibit						

TABLE 1: MCH PIN OUT

MCH PINS NOT IN USE						
Inhibit	Leave unconnected					
"No Connection" pin	Leave unconnected					

TABLE 2: MCH PINS NOT IN USE



See Figure 20 on page 12 for dimensions.

FIGURE 2: MCH PIN OUT

## **12 TO 50 VOLT INPUT - 1.5 WATT**

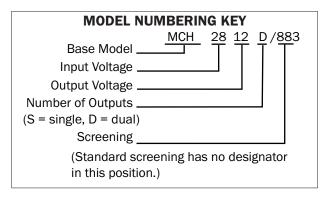


FIGURE 3: MCH MODEL NUMBERING KEY

SMD NUMBERS MCH MODELS									
MCH SIMILAR PART									
MCH2805S/883									
MCH2812S/883									
MCH2815S/883									
MCH2805D/883									
MCH2812D/883									
MCH2815D/883									

SMD numbers shown are for screening level Class H, standard case (X), standard pin seal and non-solder dipped pins (C). For other options please refer to the SMD for the SMD number and the vendor similar number. All SMD numbers are listed on the SMD in the "Bulletin" which is the last page of the SMD. For exact specifications for an SMD product, refer to the SMD. SMDs can be downloaded from https://landandmaritimeapps.dla.mil/programs/smcr

TABLE 3: MCH SMD NUMBER CROSS REFERENCE

	MODEL NUMBER OPTIONS  To determine the model number enter one option from each category in the form below.									
CATEGORY Base Model and Input Voltage Output Voltage Number of Outputs 1 Case Options 2 S										
		05, 12, 15	S	MCH - down-leaded: leave blank	(standard, leave blank)					
OPTIONS	MCH28	05, 12, 15	D		ES					
					883					
FILL IN FOR MODEL # <sup>4</sup>	MCH28				/					

#### Notes

- 1. Number of Outputs: S is a single output and D is a dual output
- 2. Case Options: For the standard MCH down-leaded case leave the case option blank.
- 3. Screening: For standard screening leave the screening option blank. For other screening options, insert the desired screening level. For more information see Table 12 on page 14.
- 4. If ordering MCH (down-leaded) case by model number add a "-Q" to request solder dipped leads (MCH2805S/883-Q).

TABLE 4: MCH MODEL NUMBER OPTIONS

# **12 TO 50 VOLT INPUT - 1.5 WATT**

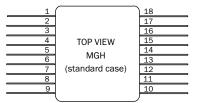
PIN OUT MGH MODELS								
Pin	Single Output	Dual Output						
1	Positive Input	Positive Input						
2	No Connection	No Connection						
3	Input Common	Input Common						
4, 5	Positive Output	Positive Output						
6, 7	Case Ground	Case Ground						
8, 9	Output Common	Output Common						
10, 11	Case Ground	Case Ground						
12	No Connection	No Connection						
13, 14	No Connection	Negative Output						
15, 16, 17	No Connection	No Connection						
18	Inhibit	Inhibit						

To meet specified performance for the MGH, all pins must be connected except "No connection" pins and Inhibit pin.

TABLE 5: MGH PIN OUT

MGH PINS NOT IN USE						
Inhibit	Leave unconnected					
"No Connection" pins	Connect to case ground for best EMI performance. Also ok to leave unconnected.					

TABLE 6: MGH PINS NOT IN USE



Differently colored glass bead around pin one or dimple in header (bottom or side of case) indicates pin one.

Cover marking is oriented with pin one at the upper right corner.

See Figure 21 on page 13 for dimensions and "gull-wing" option.

FIGURE 4: MGH PIN OUT

# 12 TO 50 VOLT INPUT - 1.5 WATT

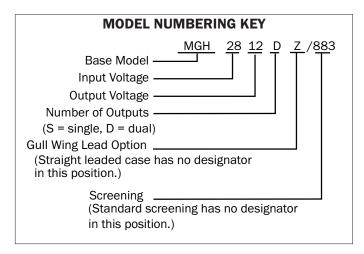


FIGURE 5: MGH MODEL NUMBERING KEY

SMD NUMBERS MGH MODELS									
STANDARD MICROCIRCUIT DRAWING (SMD)	MGH SIMILAR PART								
5962-9569601HZA	MGH2805SZ/883								
5962-9569701HZA	MGH2812SZ/883								
5962-9569801HZA	MGH2815SZ/883								
5962-9570201HZA	MGH2805DZ/883								
5962-9570301HZA	MGH2812DZ/883								
5962-9570401HZA	MGH2815DZ/883								

SMD numbers shown are for screening level Class H, standard flat pack case (Z), standard pin seal and solder dipped pins (A). For other options please refer to the SMD for the SMD number and the vendor similar number. All SMD numbers are listed on the SMD in the "Bulletin" which is the last page of the SMD. For exact specifications for an SMD product, refer to the SMD. SMDs can be downloaded from https://landandmaritimeapps.dla.mil/programs/smcr

TABLE 7: MGH SMD NUMBER CROSS REFERENCE

MODEL NUMBER OPTIONS  To determine the model number enter one option from each category in the form below.										
CATEGORY Base Model and Input Voltage Output Voltage Outputs 1 Case Options 2 Screening 3										
		05, 12, 15	S	MGH – straight leads: leave blank	(standard, leave blank)					
OPTIONS	MGH28	05, 12, 15	D	MGH - gull wings: Z (always solder-dipped)	ES					
					883					
FILL IN FOR MODEL # <sup>4</sup>	MGH28				/					

#### Notes

- 1. Number of Outputs: S is a single output and D is a dual output
- 2. Case Options: For the MGH straight-lead case, leave the case option blank. For the surface mount gull-wing case, insert the letter "Z" in the case option position.
- 3. Screening: For standard screening leave the screening option blank. For other screening options, insert the desired screening level. For more information see Table 12 on page 14
- 4. If ordering the MGH straight leads can be ordered "solder-dipped" by adding a Q to the model number MGH2805S-Q. The MGH case Z is always solder-dipped.

TABLE 8: MGH MODEL NUMBER OPTIONS

# **12 TO 50 VOLT INPUT - 1.5 WATT**

Table 9: Operating Conditions - All Models, 25 °C case, 28 Vin, unless otherwise specified.

		ALL MODELS				
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
LEAD SOLDERING TEMPERATURE <sup>1</sup>	10 SECONDS MAX.	_	_	300	°C	
SURFACE MOUNT SOLDER REFLOW 1, 2	SN 60, 62 OR 63 RECOMMENDED	2	20°C for max	of 30 se	conds	
STORAGE TEMPERATURE <sup>1</sup>		-65	_	+150	°C	
CASE OPERATING	FULL POWER	-55	_	+125	°C	
TEMPERATURE	ABSOLUTE <sup>1</sup>	-55	_	+135		
DERATING OUTPUT POWER/CURRENT <sup>1</sup>	LINEARLY	From	at 135°C			
ISOLATION: INPUT TO OUTPUT, INPUT TO	@ 500 VDC AT 25°C	100			Megohms	
CASE, OUTPUT TO CASE <sup>3</sup>	@ 500 VDC AT 25 C	100	_	_	iviegorinis	
INPUT TO OUTPUT CAPACITANCE <sup>1</sup>		_	100 - 170	_	pF	
UNDERVOLTAGE LOCKOUT <sup>1</sup>		_	8	_	V <sub>IN</sub>	
CURRENT LIMIT <sup>1, 4</sup>	% OF FULL LOAD	_	125	_	%	
AUDIO REJECTION <sup>1</sup>		_	40	_	dB	
SWITCHING FREQUENCY	-55° TO +125°C	270	370	470	kHz	
INHIBIT ACTIVE LOW (OUTPUT DISABLED)	INHIBIT PIN PULLED LOW	_	_	0.8	V	
Do not apply a voltage to the inhibit pin. $^{\rm 5}$	INHIBIT PIN SOURCE CURRENT <sup>1</sup>	_	_	1	mA	
	REFERENCED TO	INPUT COMMON				
INHIBIT ACTIVE HIGH (OUTPUT ENABLED)	INHIBIT PIN CONDITION	OPEN	NNECTED			
Do not apply a voltage to the inhibit pin. $^{\rm 5}$	OPEN PIN VOLTAGE <sup>1</sup>	7	_	12	V	

#### Notes

- 1. Guaranteed by characterization test and/or analysis. Not a production test.
- 2. See Figure 22 on page 13 for more information
- 3. When testing isolation, input pins are tied together and output pins are tied together. They are tested against each other and against case. Discharge the pins before and after testing.
- 4. Dual outputs: The over-current limit will trigger when the sum of the currents from both outputs reaches 125% (typical value) of the maximum rated "total" current of both outputs.
- 5. An external inhibit interface should be used to pull the inhibit low or leave it floating. The inhibit pin can be left unconnected if not used.

# **12 TO 50 VOLT INPUT - 1.5 WATT**

Table 10: Electrical Characteristics -55°C to +125°C case, 28 Vin, 100% load, unless otherwise specified.

		MCH2805S		MCH2812S		MCH2815S					
MCH/MGH SINGLE OUTPUT	MODELS	N	1GH2805	SS .	M	IGH2812	<u>2</u> S	N	IGH2815	S	
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
OUTPUT VOLTAGE <sup>2</sup>		4.80	5.00	5.20	11.52	12.00	12.48	14.40	15.00	15.60	V
OUTPUT CURRENT	V <sub>IN</sub> = 12 TO 50	0	_	300	0	_	125	0	_	100	mA
OUTPUT POWER	V <sub>IN</sub> = 12 TO 50	0	_	1.5	0	_	1.5	0	_	1.5	W
OUTPUT RIPPLE	T <sub>C</sub> = 25°C	_	45	150	_	50	200	_	35	150	mV p-p
10 kHz - 2 MHz	T <sub>C</sub> = -55°C TO +125°C	_	65	300	_	70	300	_	50	250	illy b-b
LINE REGULATION	V <sub>IN</sub> = 12 TO 50	_	40	120	_	70	250	_	80	350	mV
LOAD REGULATION 3	10% LOAD TO FULL	_	380	800	_	640	1400	_	760	1600	mV
INPUT VOLTAGE	CONTINUOUS	12	28	50	12	28	50	12	28	50	V
NO LOAD TO FULL	TRANSIENT <sup>1</sup> 120 msec.	_	_	80	_	_	80	_	_	70	\ \ \
INPUT CURRENT	NO LOAD	_	6.0	11	_	6.5	12	_	6.5	12	mA
	INHIBITED	_	2.4	3.5	_	2.4	3.5	_	2.4	3.5	IIIA
INPUT RIPPLE CURRENT <sup>4</sup>	10 kHz - 10 MHz	_	130	250	_	150	250	_	150	250	mA p-p
EFFICIENCY	T <sub>C</sub> = 25°C	72	77	_	74	79	_	74	79	_	%
	$T_C = -55$ °C TO +125°C	69	75	_	72	77	_	72	77	_	70
LOAD FAULT 5, 6	POWER DISSIPATION	_	1.4	2.3	_	2.2	3.5	_	2.5	4.0	W
SHORT CIRCUIT	RECOVERY <sup>1</sup>	_	3.5	15	_	3.5	20	_	4.0	20	ms
STEP LOAD RESPONSE 6, 7	TRANSIENT	_	±185	±500	_	±380	±800	_	±380	±800	mV pk
50% - 100% - 50%	RECOVERY	_	125	600	_	130	600	_	180	750	μs
STEP LINE RESPONSE <sup>1, 6, 8,</sup>	TRANSIENT	_	180	±500	_	±400	±1000	_	±450	±850	mV pk
V <sub>IN</sub> = 12 - 50 - 12	RECOVERY	_	0.75	4.0	_	0.6	3.0	_	0.5	2.5	ms
START-UP <sup>6</sup>	DELAY	_	10	40	_	10	40	_	10	40	ms
V <sub>IN</sub> = 0 - 28, FULL LOAD	OVERSHOOT <sup>1</sup>	_	0	150	_	0	350	_	0	450	mV pk
CAPACITIVE LOAD <sup>1, 9</sup>	T <sub>C</sub> = 25°C	_	_	200	_	_	200	_	_	200	μF

#### Notes

- 1. Guaranteed by characterization test and/or analysis. Not a production test.
- 2. Specified at 50% total Pout.
- 3. Although no minimum load is required, at no load the output voltage may increase up to 15%
- $4.\,\mbox{An external 2}~\mbox{$\mu$H}$  inductor, added in series to the input, is necessary to maintain specifications.
- 5. Load fault is a short circuit (<50 mohms). Maximum duration of short circuit:  $25\,^{\circ}$ C 90 seconds,  $125\,^{\circ}$ C 30 seconds. Recovery is into resistive full load.
- 6. Recovery time is measured from application of the transient to point at which Vout is within 1% of final value.
- 7. Step load test is performed at 10 microseconds typical.
- 8. Step line test is performed at 100 microseconds  $\pm$  20 microseconds.
- 9. No effect on DC performance.

# **12 TO 50 VOLT INPUT - 1.5 WATT**

Table 11: Electrical Characteristics -55°C to +125°C case, 28 Vin, 100% load, unless otherwise specified.

		MCH2805D			MCH2812D			MCH2815D			
MCH/MGH DUAL OUTPUT M	ODELS	l N	IGH2805	5D	M	IGH2812	!D	M	IGH2815	5D	
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
OUTPUT VOLTAGE <sup>2</sup>	±V <sub>OUT</sub>	4.80	5.00	5.20	11.52	12.00	12.48	14.40	15.00	15.60	V
OUTPUT CURRENT 3	EITHER OUTPUT	0	±150	240	0	±62.5	100	0	±50	80	А
V <sub>IN</sub> = 12 TO 50	TOTAL OUTPUT	_	_	300	_	_	125	_	_	100	mA mA
OUTPUT POWER <sup>3</sup>	EITHER OUTPUT	0	±0.75	1.2	0	±0.75	1.2	0	±0.75	1.2	W
V <sub>IN</sub> = 12 TO 50	TOTAL OUTPUT	_	_	1.5	_	_	1.5	_	_	1.5	, vv
OUTPUT RIPPLE	T <sub>C</sub> = 25°C	_	35	150	_	35	150	_	30	150	ma\/ m m
10 kHz - 2 MHz $\pm$ V <sub>OUT</sub>	T <sub>C</sub> = -55°C TO +125°C	_	50	250	_	40	250	_	35	250	mV p-p
LINE REGULATION ±V <sub>OUT</sub>	V <sub>IN</sub> = 12 TO 50	_	20	100	_	110	400	_	180	650	mV
LOAD REGULATION <sup>4</sup> ±V <sub>OUT</sub>	10% LOAD TO FULL	_	350	700	_	570	1200	_	630	1400	mV
CROSS REGULATION 5	-V <sub>OUT</sub>	_	_	400	_	_	500	_	_	500	mV
INPUT VOLTAGE	CONTINUOUS	12	28	50	12	28	50	12	28	50	V
NO LOAD TO FULL	TRANSIENT <sup>1</sup> 120 msec.	_	_	80	_	_	80	_	_	70	V
INPUT CURRENT	NO LOAD	_	6.0	12	_	8.0	14	_	8.0	14	mA
	INHIBITED	_	2.4	3.5	_	2.4	3.5	_	2.4	3.5	IIIA
INPUT RIPPLE CURRENT 6	10 kHz - 10 MHz	_	130	250	_	150	250	_	150	250	mA p-p
EFFICIENCY	T <sub>C</sub> = 25°C	73	77	_	73	77	_	72	76	_	%
	T <sub>C</sub> = -55°C TO +125°C	70	75	_	70	75	_	69	74	_	70
LOAD FAULT <sup>6, 7</sup>	POWER DISSIPATION	_	1.6	2.5	_	2.7	4.2	_	3.0	4.5	W
SHORT CIRCUIT	RECOVERY <sup>1</sup>	_	3.8	20	_	3.2	20	_	4.0	20	ms
STEP LOAD RESPONSE 7, 8	TRANSIENT	_	±140	±400	_	±260	±700	_	±270	±700	mV pk
50% - 100% - 50%	RECOVERY	_	100	500	_	165	800	_	50	300	μs
STEP LINE RESPONSE 1, 7, 9	TRANSIENT	_	±130	±300	_	±250	±600	_	±230	±600	mV pk
V <sub>IN</sub> = 12 - 50 - 12	RECOVERY	_	0.6	3.0	_	0.9	4.0	_	0.7	4.0	ms
START-UP <sup>7</sup>	DELAY	_	10	45	_	10	45	_	10	45	ms
V <sub>IN</sub> = 0 TO 28, FULL LOAD	OVERSHOOT <sup>1</sup>	_	0	150	_	0	350	_	0	900	mV pk
CAPACITIVE LOAD <sup>1, 10</sup>	T <sub>C</sub> = 25°C	_	_	100	_	_	100	_	_	100	μF

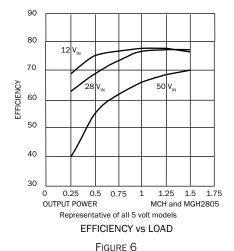
#### Notes

- 1. Guaranteed by characterization test and/or analysis. Not a production test.
- 2. Specified at 50% total  $\mathrm{P}_{\mathrm{OUT}}$  with balanced loads.
- 3. Up to 80% of the total output current/power is available from either output providing the opposite output carries a minimum of 20% total load.
- 4. Although no minimum load is required, at no load the output voltage may increase up to 15%
- 5. Cross regulation is specified as the effect on –Vout for the following percentages of total output power: +Po = 20% and –Po = 80% to +Po=80% and –Po=20%
- 6. Load fault is a short circuit (<50 mohms). Maximum duration of short circuit: 25°C 90 seconds, 125°C 30 seconds. Recovery is into resistive full load.
- Recovery time is measured from application of the transient to point at which Vout is within 1% of final value.
- 8. Step load test is performed at 10 microseconds typical.
- 9. Step line test is performed at 100 microseconds  $\pm$  20 microseconds.
- 10. No effect on DC performance.

# **12 TO 50 VOLT INPUT - 1.5 WATT**

TYPICAL PERFORMANCE PLOTS: 28 VIN, 25 °C CASE, 100% LOAD, UNLESS OTHERWISE SPECIFIED.

THESE ARE EXAMPLES FOR REFERENCE ONLY AND ARE NOT GUARANTEED SPECIFICATIONS.



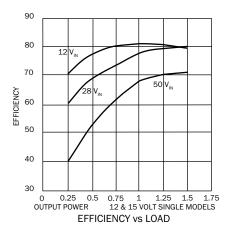
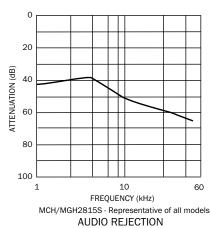


FIGURE 7

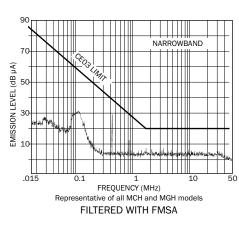


120 100 TRIP POINT 125%

SAFE OPERATING AREA

40 20

0



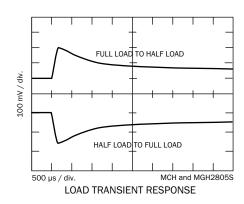


FIGURE 8



80 100

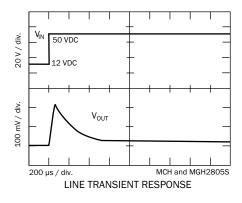
% OF FULL LOAD

OUTPUT VOLTAGE vs. OUTPUT LOAD

120 140

FIGURE TO

FIGURE 11



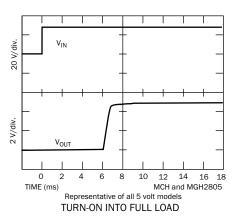


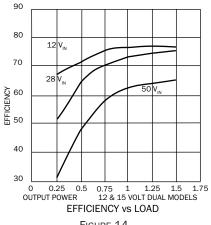
FIGURE 12

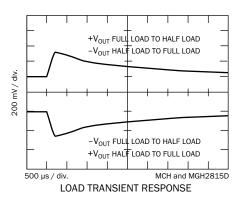
FIGURE 13

# **12 TO 50 VOLT INPUT - 1.5 WATT**

TYPICAL PERFORMANCE PLOTS: 28 VIN, 25 °C CASE, 100% LOAD, UNLESS OTHERWISE SPECIFIED.

THESE ARE EXAMPLES FOR REFERENCE ONLY AND ARE NOT GUARANTEED SPECIFICATIONS.





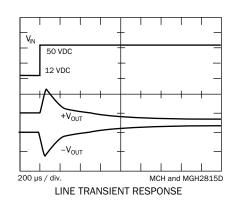
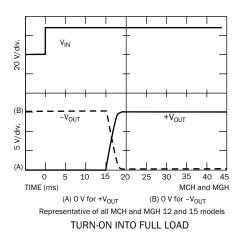
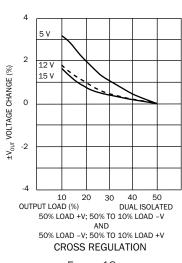


FIGURE 14

FIGURE 15







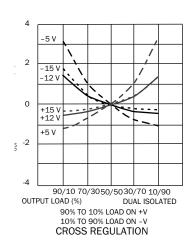


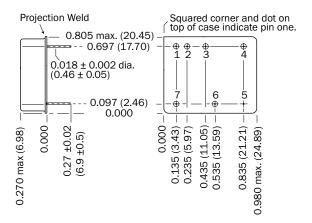
FIGURE 17

FIGURE 18

FIGURE 19

# **12 TO 50 VOLT INPUT - 1.5 WATT**

#### **BOTTOM VIEW CASE A2**



Weight 12 grams typical

Case dimensions in inches (mm)

Tolerance  $\pm 0.005$  (0.13) for three decimal places  $\pm 0.01$  (0.3) for two decimal places unless otherwise specified

## CAUTION

Solder pins individually with heat application not exceeding 300°C for 10 seconds per pin.

#### Materials

Header Kovar/Nickel/Gold Cover Kovar/Nickel

Pins Kovar/Nickel/Gold matched glass seal

Gold plating of 50 microinches, minimum,

included in pin diameter

Seal hole: 0.056 ±0.002 (1.42 ±0.05)

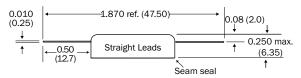
Please refer to the numerical dimensions for accuracy.

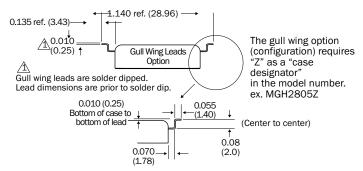
FIGURE 20: MCH CASE DIMENSIONS
DOWN-LEADED CASE

## **12 TO 50 VOLT INPUT - 1.5 WATT**

#### TOP VIEW CASE B 0.880 max (22.35)0.900 (22.86) 0.800 (20.32) 0.700 (17.78) 0.600 (15.24) (This view shows 1.010 max 0.500 (12.70) straight leads.) (25.65)0.400 (10.16) 0.015 0.300 ( 7.62) (0.38)0.200 ( 5.08) 0.100 ( 2.54) 0.000-0.000

The triangle (ESD) marking on the cover indicates pin one. Cover marking is oriented with pin one at the upper right corner. The straight lead configuration does not require a "case designator" in the model number. ex. MGH2805S





Weight 12 grams maximum

#### Case dimensions in inches (mm)

Tolerance  $\pm 0.005$  (0.13) for three decimal places,  $\pm 0.01$  (0.3) for two decimal places unless otherwise specified. Please refer to the numerical dimensions for accuracy.

## CAUTION

Maximum reflow temperature is 220°C for a maximum of 30 seconds. SN60, SN62, or SN63 are the recommended types of solder. See MGH gull-wing solder pad layout. Hand soldering should not exceed 300°C for 10 seconds per pin.

#### Materials

Header Kovar/Nickel/Gold Cover Kovar/Nickel

Pins Kovar/Nickel/Gold matched glass seal

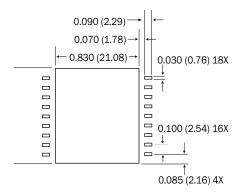
Gold plating of 50 - 150 microinches is included in pin diameter

Seal hole: 0.040 ±0.002 (1.02 ±0.05)

Please refer to the numerical dimensions for accuracy.

FIGURE 21: MGH CASE DIMENSIONS

#### CASE B1 GULL-WING SOLDER PADS



## Dimensions in inches (mm)

Tolerance  $\pm 0.005$  (0.13) for three decimal places  $\pm 0.01$  (0.3) for two decimal places, unless otherwise specified. Please refer to the numerical dimensions for accuracy.

#### CAUTION:

Internal components are soldered with SN96 (melting temperature 221°C) to prevent damage during reflow. Maximum reflow temperature for surface mounting the MGH converter is 220°C for a maximum of 30 seconds. SN60, 62, or 63 are the recommended types of solder.

Hand soldering should not exceed 300°C for 10 seconds per pin.

#### SOLDER MASK NOTES

- 1. Pad dimensions are for the solder mask. Leads common to each other can be connected to each other as desired.
- 2. Ground (case) pins should be connected to the center pad for improved grounding.
- 3. Connect "no connection" pins to case ground to reduce EMI.
- 4. Center pad should not have a solder mask.
- 5. Adhesive attach is intended to be a surface for soldering the hybrid to the circuit board.
- 6. Pre-tin base of converter prior to soldering.
- 7. If less rotation of case is desired, reduce the width of the large case pad by 0.020 inches (0.51 mm). Pad length can be extended 0.010 inches (0.25 mm) towards the case body and an as-desired dimension away from the case body.
- 8. Do not exceed 220 °C as measured on the body of the converter (top or bottom).
- 9. Attach the body of the case to the board with a thermally conductive adhesive or SN60, 62, or 63 solder. The adhesive can be electrically conductive as well. It can be applied as an underfill post solder or dispensed and cured prior or during solder.
- 10. In the presence of vibration, to ensure reliable mechanical attachment, the body of the case should be attached with adhesive or solder as noted above (note 7). The leads alone do not provide sufficient mechanical attachment.

FIGURE 22: MGH GULL-WING SOLDER PAD LAYOUT

SURFACE MOUNT CASE AND LEAD OPTIONS

## 12 TO 50 VOLT INPUT - 1.5 WATT

ELEMENT EVALUATION TABLES FOR QML PRODUCTS ARE IN "APP-009 QUALITY AND CERTIFICATION", APPENDIX A, IN COMPLIANCE WITH MIL-PRF-38534 REVISION L.

( LINK HTTPS://www.craneae.com/quality-assurance-modular-power )

# ENVIRONMENTAL SCREENING HIGH RELIABILITY STANDARD, /ES, /SX AND /883 (CLASS H)

TEST PERFORMED	NON-QML <sup>1</sup>			CLASS H QML <sup>2, 3</sup>
	STANDARD	/ES	/SX <sup>4</sup>	/883
Pre-cap Inspection, Method 2017, 2032				•
Temperature Cycle (10 times)				
Method 1010, Cond. C, -65 °C to +150 °C, ambient			•	
Method 1010, Cond. B, -55°C to +125°C, ambient				
Constant Acceleration				
Method 2001, 3000 g			•	
Method 2001, 500 g				
PIND, Test Method 2020, Cond. A			■ 5	■ 5
Burn-in Method 1015, +125°C case, typical <sup>6</sup>				
96 hours				
160 hours				•
Final Electrical Test, MIL-PRF-38534, Group A,				
Subgroups 1 through 6, -55°C, +25°C, +125°C case				
Subgroups 1 and 4, +25°C case		•		
Hermeticity Test, Method 1014				
Gross Leak, Cond. C <sub>1</sub> , fluorocarbon			•	
Fine Leak, Cond. A <sub>2</sub> , helium		•		•
Gross Leak, Dip				
Final visual inspection, Method 2009			•	

Test methods are referenced to MIL-STD-883 as determined by MIL-PRF-38534.

#### Notes

- 1. Non-QML products may not meet all of the requirements of MIL-PRF-38534.
- 2. All processes are QML qualified and performed by certified operators.
- 3. A QML products which has an SMD number is marked "QML". A QML product which does not have an SMD number is marked per MIL-PRF-38534 table III.
- $4.\ {\rm ``SX"}\ screening\ is\ performed\ per\ MIL-PRF-38534,\ MIL-STD-883,\ Class\ H\ for\ non-QML\ devices.$
- 5. Not required by DLA but performed to assure product quality.
- 6. Burn-in temperature designed to bring the case temperature to +125 °C minimum. Burn-in is a powered test.

Table 12: Environmental Screening High Reliability Standard, /es and /833 (class  ${\rm H}$ )

